

PSE Technology Corporation SPECIFICATION FOR APPROVAL

CUSTOMER			
NOMINAL FREQUENCY	24.000000 MHz		
HOLDER TYPE	TYPE FY 5.0x3.2 SEAM SEALED CRYSTAL		
SPEC. NO. (P/N)	FY2400054		
CUSTOMER P/N			
ISSUE DATE	March 1, 2011		
VERSION	C		
SPEC. NO. (P/N) CUSTOMER P/N ISSUE DATE	FY2400054 March 1, 2011		

APPROVED	PREPARED	QA
Alan Yang	Brenda	Canthur
APPROVED BY CUSTOMER:		AVL Status
Please return one copy v	vith approval to PSE-TW	

PSE Technology Corporation

No.2, Tzu-Chiang 5th Rd, Chung Li Industrial Park, Chung Li City, Taoyuan County, Taiwan (R.O.C.)

TEL: 886-3-451-8888 FAX: 886-3-461-3865

http://www.saronix-ecera.com.tw

*Pb-free

*RoHS Compliant

*HF-Halogen Free

*REACH Compliant



*** A company of PERICOM Semiconductor Corporation ***

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VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
А	Jun.15,2010			Initial Release	
В	Aug.12,2010			New Logo	
С	Mar.1,2011			Updated Suggested IR Reflow Profile & Format	

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ELECTRICAL SPECIFICATIONS

ltem	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	24.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	FL	±30	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +85	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±30	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	50	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±5	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	МΩ	Min

** This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY : (RoHS version): J-STD-002

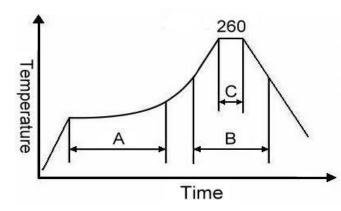
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



Note:

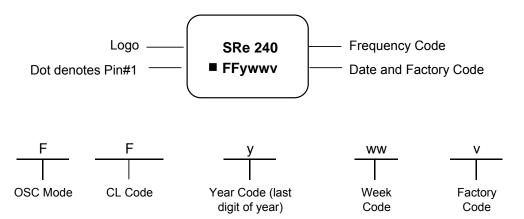
	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

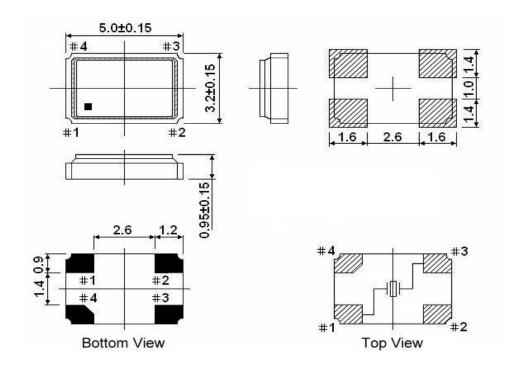
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MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

Note:

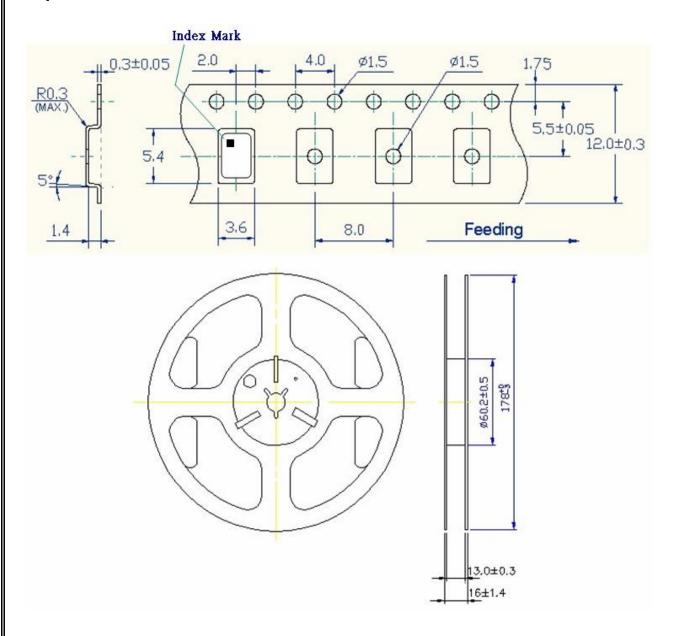
- 1. The marking dot denotes Pin#1.
- 2. Pin positions of the drawing is only for reference, and the Pin with chamfer is based on the real product.



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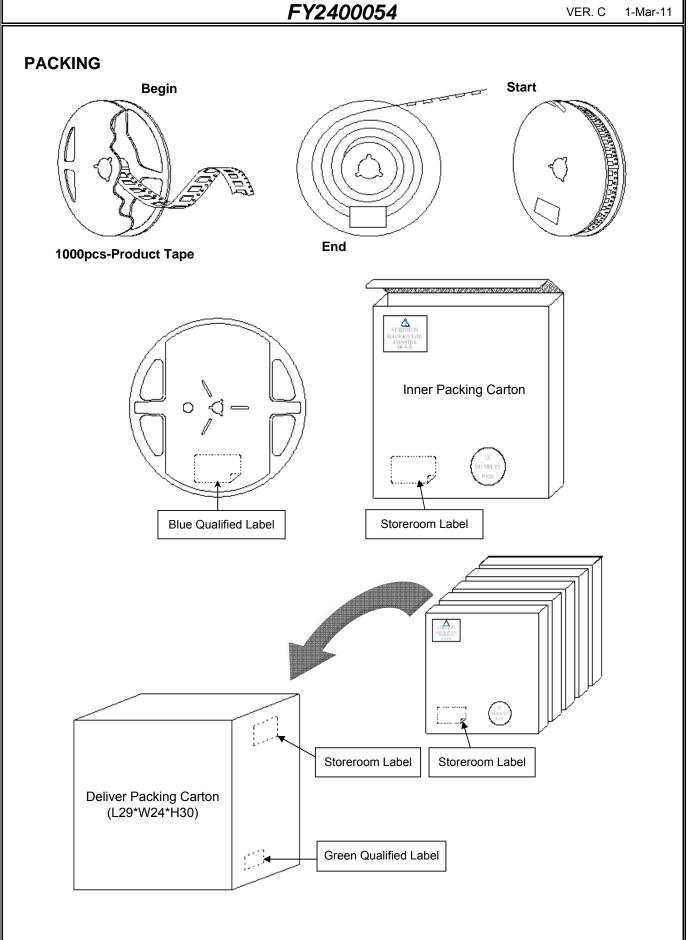
Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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Mouser Electronics

Authorized Distributor

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